TOSHIBA TC55V11601FT-15

TOSHIBA MOS DIGITAL INTEGRATED CIRCUIT SILICON GATE CMOS

16,777,216-WORD BY 1-BIT CMOS STATIC RAM

DESCRIPTION

The TC55V11601FT is a 16,777,216-bit high speed static random access memory (SRAM) organized as 16,777,216 words by 1 bit. Fabricated using CMOS technology and advanced circuit techniques to provide high speed, it operates from a single 3.3 V power supply. Chip enable (\overline{CE}) can be used to place the device in a lowpower mode, and output enable (\overline{OE}) provides fast memory access. This device is well suited to cache memory applications where high-speed access and high-speed storage are required. All inputs and outputs are isolated and directly LVTTL compatible. The TC55V11601FT is available in a plastic 54-pin TSOP package with 400 mil width for high density surface assembly.

FEATURES

- Fast access time (the following are maximum values) Single power supply voltage of 3.3V ± 0.3V TC55V11601FT-15:15 ns
- Low-power dissipation

Cycle Time	15	30	ns
Operation (max)	200	130	mA

Standby: 4mA(max)

- Fully static operation
- All inputs and outputs are LVTTL compatible
- Separate data input and output
- Output buffer control using \overline{OE}
- Package:

TSOP II 54-P-400-0.80B (FT) (Weight: 0.55 g typ)

PIN ASSIGNMENT

PIN NAMES

A0 to A23	Address Inputs	
D	Data Input	
Q	Data Output	
CE	Chip Enable Input	
WE	Write Enable Input	
ŌĒ	Output Enable Input	
V_{DD}	Power (+ 3.3 V)	
GND	Ground	
NU1, NU2	Not Usable	

000707EBA2

TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.

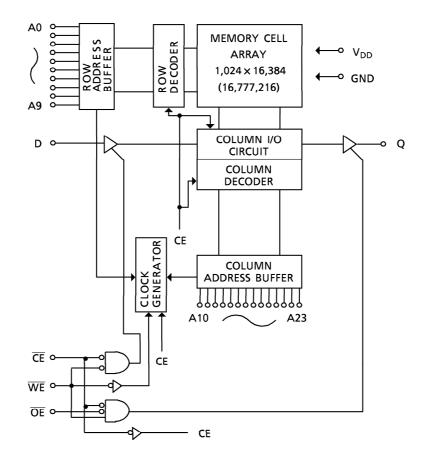
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..

The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, transfic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.

The products described in this document are subject to the foreign exchange and foreign trade laws.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of toshiBA CORPORA

BLOCK DIAGRAM



MAXIMUM RATINGS

SYMBOL	RATING	VALUE	UNIT
V_{DD}	Power Supply Voltage	- 0.5 to 4.6	V
V _{IN}	Input Terminal Voltage	- 0.5* to 4.6	V
V _{I/O}	Input/Output Terminal Voltage	- 0.5* to V _{DD} + 0.5**	V
P _D	Power Dissipation	1.8	W
T _{solder}	Soldering Temperature (10 s)	260	°C
T _{strg}	Storage Temperature	- 65 to 150	°C
T _{opr}	Operating Temperature	- 10 to 85	°C

*: -1.5V with a pulse width of $20\% \cdot {}^{t}RC$ min (4ns max)
**: $V_{DD}+1.5V$ with a pulse width of $20\% \cdot {}^{t}RC$ min (4ns max)

DC RECOMMENDED OPERATING CONDITIONS (Ta = 0° to 70°C)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
V_{DD}	Power Supply Voltage	3.0	3.3	3.6	V
V _{IH}	Input High Voltage	2.0	-	V _{DD} + 0.3**	V
V _{IL}	Input Low Voltage	- 0.3*	_	0.8	٧

*: -1.0V with a pulse width of $20\% \cdot {}^{t}RC$ min (4ns max)
**: $V_{DD}+1.0V$ with a pulse width of $20\% \cdot {}^{t}RC$ min (4ns max)

DC CHARACTERISTICS (Ta = 0° to 70° C, V_{DD} = $3.3V \pm 0.3V$)

SYMBOL	PARAMETER	TEST CONDITION		MIN	TYP	MAX	UNIT
I _{IL}	Input Leakage Current (Except NU1 pin)	V _{IN} = 0 to V _{DD}		– 1	ı	1	μΑ
I _{LO}	Output Leakage Current	$\overline{CE} = V_{IH}$ or $\overline{WE} = V_{IL}$ or $\overline{OE} = V_{IH}$ $V_{OUT} = 0$ to V_{DD}		– 1	I	1	μΑ
1 (81114)	land Compat (NUIA min)	V _{IN} = 0 to 0.8V		– 1	ı	20	
I ₁ (NU1)	Input Current (NU1 pin) V _{IN} = 0 to 0.2V		– 1	ı	1	μΑ	
M	Outros High Voltage	I _{OH} = -2mA		2.4	ı	_	
V _{OH}	Output High Voltage $I_{OH} = -100\mu$ A		V _{DD} – 0.2	ı	_	.,	
.,		I _{OL} = 2mA		_	ı	0.4	V
V _{OL}	Output Low Voltage	I _{OL} = 100 <i>μ</i> A		_	ì	0.2	
		$\overline{CE} = V_{IL}$, lout = 0mA	tcycle = 15ns	_	-	200	
I _{DDO} Operating Current		$\overline{OE} = V_{IH}$ Other Inputs = $V_{DD} - 0.2V$ or 0.2V	tcycle = 30ns	_	-	130	mA
I _{DDS 1}		$\overline{CE} = V_{IH}$, Other Inputs = V_{IH} or V_{IL}		-	1	65	
I _{DDS 2}	Standby Current $\overline{CE} = V_{DD} - 0.2V$		-	ı	4	mA	

<u>CAPACITANCE</u> (Ta = 25° C, f = 1.0 MHz)

SYMBOL	PARAMETER	TEST CONDITION	MAX	UNIT
C _{IN}	Input Capacitance	V _{IN} = GND	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = GND	8	pF

Note: This parameter is periodically sampled and is not 100% tested.

OPERATING MODE

MODE	CE	ŌĒ	WE	D	Q	POWER
Read	L	L	Н	Х	Dout	I _{DDO}
Write	L	Х	L	Din	High-Z	I _{DDO}
Outputs Disable	L	Н	Н	х	High-Z	I _{DDO}
Standby	Н	Х	Х	Х	High-Z	I _{DD\$}

X: Don't care

Note: The NU1 and NU2 pins must be left unconnected or tied to GND or a voltage level of less than 0.8 V. You must not apply a voltage of more than 0.8 V to the NU1 and NU2.

AC CHARACTERISTICS (Ta = 0° to 70° C (Note 1), $V_{DD} = 3.3V \pm 0.3V$)

READ CYCLE

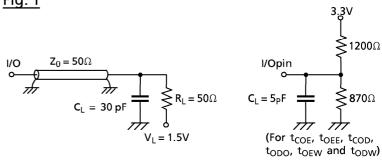
SYMBOL	PARAMETER	TC55V11	UNIT	
STIVIBOL	PARAWEIER	MIN	MAX	UNIT
t _{RC}	Read Cycle Time	15	_	
t _{ACC}	Address Access Time	_	15	
t _{CO}	Chip Enable Access Time	-	15	
t _{OE}	Output Enable Access Time	_	8	
t _{OH}	Output Data Hold Time from Address Change	3	_	ns
t _{COE}	Output Enable Time from Chip Enable	3	-	
t _{OEE}	Output Enable Time from Output Enable	1	_	
t _{COD}	Output Disable Time from Chip Enable	_	8	
t _{ODO}	Output Disable Time from Output Enable	_	8	

WRITE CYCLE

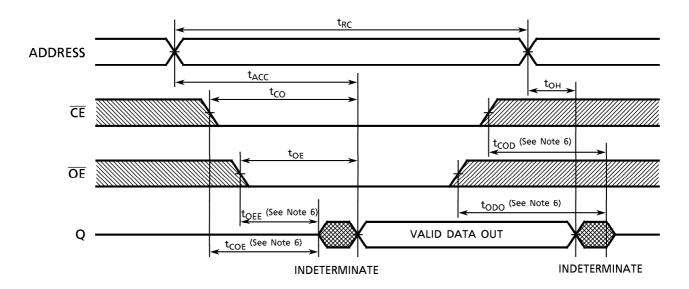
SYMBOL	DARAMETER	TC55V11	UNIT	
STIVIBUL	PARAMETER	MIN	MAX	UNII
t _{WC}	Write Cycle Time	15	_	
t_WP	Write Pulse Width	10	_	
t _{CW}	Chip Enable to End of Write	11	-	
t _{AW}	Address Valid to End of Write	11	-	
t _{AS}	Address Setup Time	0	-	
t _{WR}	Write Recovery Time	0	_	ns
t _{DS}	Data Setup Time	8	-	
t _{DH}	Data Hold Time	0	_	
t _{OEW}	Output Enable Time from Write Enable	1	-	
t _{ODW}	Output Disable Time from Write Enable	_	8	

AC TEST CONDITIONS

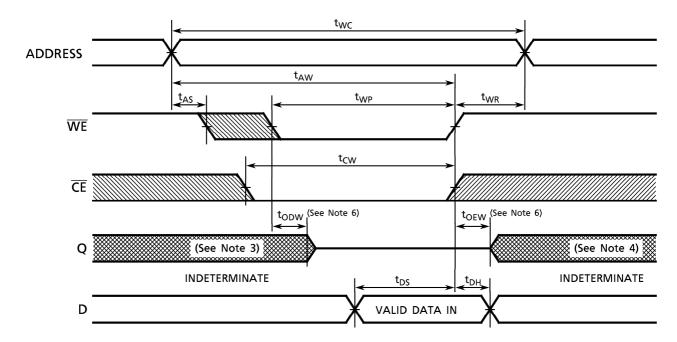
Input Pulse Level	3.0V/0.0V
Input Pulse Rise and Fall Time	2ns
Input Timing Measurement Reference Level	1.5V
Output Timing Measurement Reference Level	1.5V
Output Load	Fig. 1



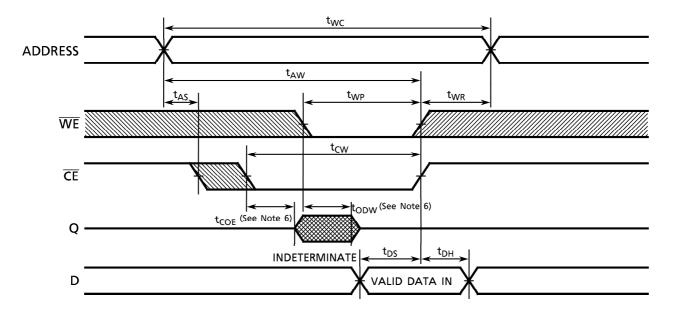
TIMING DIAGRAMS READ CYCLE (See Note 2)



WRITE CYCLE 1 (WE CONTROLLED) (See Note 5)

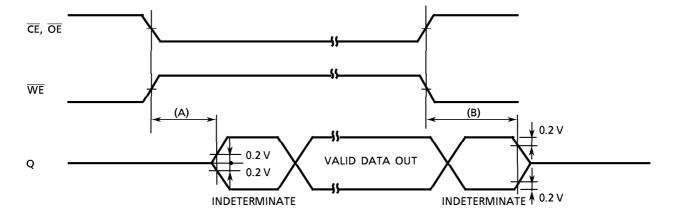


WRITE CYCLE 2 (CE CONTROLLED) (See Note 5)



Note: (1) Operating temperature (Ta) is guaranteed for transverse air flow exceeding 400 linear feet per minute.

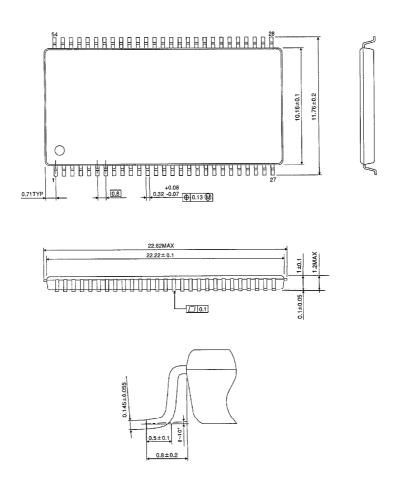
- (2) WE remains HIGH for Read Cycle.
- (3) If $\overline{\text{CE}}$ goes LOW coincident with or after $\overline{\text{WE}}$ goes LOW, the outputs will remain at high impedance.
- (4) If $\overline{\text{CE}}$ goes HIGH coincident with or before $\overline{\text{WE}}$ goes HIGH, the outputs will remain at high impedance.
- (5) If \overline{OE} is HIGH during the write cycle, the outputs will remain at high impedance.
- (6) The parameters specified below are measured using the load shown in Fig. 1.
 - (A) t_{COE}, t_{OEE}, t_{OEW} Output Enable Time
 - (B) $t_{COD}, t_{ODO}, t_{ODW} \cdots \cdots$ Output Disable Time



PACKAGE DIMENSIONS

Plastic TSOP (TSOP II 54-P-400-0.80B)

Unit in mm



Weight: 0.55g (Typ)